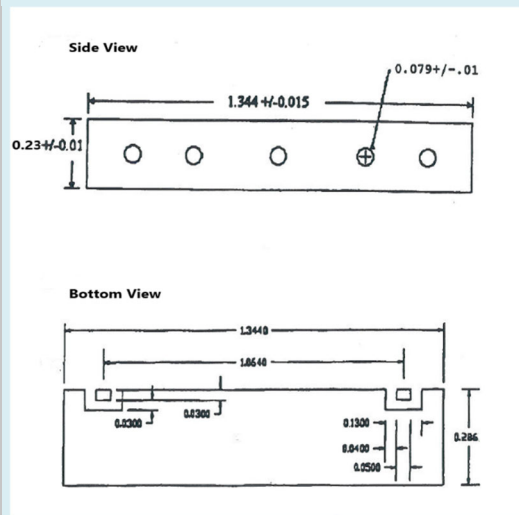


20-010 – Passive Surface Mount Block, Ceramic Bandpass Filter

<i>Information we need from your organization</i>																																																																							
Title	Passive Surface Mount Block, Ceramic Bandpass Filter																																																																						
Description	<p>Provide a Passive Surface Mount Block, Ceramic Bandpass Filter used specifically as a RF Bandpass Filter for the Global Positioning System Signal.</p> <p>The Filter is intended for use in an Automotive/Industrial environment; the thermal cycle, life, and humidity tests described are a reasonable approximation to this environment and are a very accurate representation of the reliability requirements of the module of which this device is but a single component.</p>																																																																						
Focus Area(s)	<p>Electrical Requirements - Maximum Ratings</p> <table border="1"> <thead> <tr> <th>Characteristic</th> <th>Symbol</th> <th>Value</th> <th>Units</th> </tr> </thead> <tbody> <tr> <td>Operating Ambient Temperature Range</td> <td>T_A</td> <td>-40 to +105</td> <td>°C</td> </tr> <tr> <td>Storage Temperature Range</td> <td>T_{STG}</td> <td>-65 to +150</td> <td>°C</td> </tr> <tr> <td>Lead Solder Temperature</td> <td>T_L</td> <td>+300</td> <td>°C</td> </tr> <tr> <td>Bandwidth, 3dB</td> <td>BW</td> <td>20 minimum</td> <td>MHz</td> </tr> <tr> <td>Bandwidth, 40dB</td> <td>BW</td> <td>350</td> <td>MHz</td> </tr> <tr> <td>Insertion Loss + 10MHz from Center Frequency</td> <td>IL</td> <td>1.2</td> <td>dB</td> </tr> </tbody> </table> <p>Electrical Parameters /Design Characteristics</p> <table border="1"> <thead> <tr> <th rowspan="2">Characteristic</th> <th rowspan="2">Symbol</th> <th colspan="2">T_A=-40°C</th> <th colspan="2">T_A=+25°C</th> <th colspan="2">T_A=+105°C</th> <th rowspan="2"></th> </tr> <tr> <th>Min</th> <th>Max</th> <th>Min</th> <th>Max</th> <th>Min</th> <th>Max</th> </tr> </thead> <tbody> <tr> <td>Input Impedance</td> <td>Z_i</td> <td>--</td> <td>50 Nom</td> <td>--</td> <td>50 Nom</td> <td>--</td> <td>50 Nom</td> <td>W</td> </tr> <tr> <td>Output Impedance</td> <td>Z_o</td> <td>--</td> <td>50 Nom</td> <td>--</td> <td>50 Nom</td> <td>--</td> <td>50 Nom</td> <td>W</td> </tr> <tr> <td>Return Loss +10 MHz from Center Frequency</td> <td>R_L</td> <td>12</td> <td>--</td> <td>12</td> <td>--</td> <td>12</td> <td>--</td> <td>dB</td> </tr> </tbody> </table>	Characteristic	Symbol	Value	Units	Operating Ambient Temperature Range	T _A	-40 to +105	°C	Storage Temperature Range	T _{STG}	-65 to +150	°C	Lead Solder Temperature	T _L	+300	°C	Bandwidth, 3dB	BW	20 minimum	MHz	Bandwidth, 40dB	BW	350	MHz	Insertion Loss + 10MHz from Center Frequency	IL	1.2	dB	Characteristic	Symbol	T _A =-40°C		T _A =+25°C		T _A =+105°C			Min	Max	Min	Max	Min	Max	Input Impedance	Z _i	--	50 Nom	--	50 Nom	--	50 Nom	W	Output Impedance	Z _o	--	50 Nom	--	50 Nom	--	50 Nom	W	Return Loss +10 MHz from Center Frequency	R _L	12	--	12	--	12	--	dB
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Insertion Loss +10 MHz from center frequency	I_L	--	1.2	--	1.2	--	1.2	dB
Ripple passband +10 MHz from center frequency		--	0.5	--	0.5	--	0.5	dB
Center frequency	F_0	1571.4 2	1579.4 2	1571.42	1579.4 2	1571.42	1579.4 2	MHz
Higher Order Modes		3.0	--	3.0	--	3.0	--	GHZ
Bandwidth , 3dB		20	--	20	--	20	--	MHz
Bandwidth, 40 dB		--	350	--	350	--	350	MHz

Dimensions and Configurations



VERTICAL DIMENSION TOLERANCE IS $+0.005$ UNLESS OTHERWISE NOTED.

HORIZONTAL DIMENSION TOLERANCE IS ± 0.010 UNLESS OTHERWISE NOTED.

Mechanical Requirements - Material: The body must be ceramic, with deposited silver, and trimmed to proper frequency.

Markings

The devices must be marked with as much identifying information as space allows with the information prioritized as follows:

- Supplier's Generic Number or the last five characters of the AIEG part number.
- EIA date code.

Manufacturer's symbol or EIA supplier's code.

Keyword(s)	Passive Surface Mount Block, Ceramic Bandpass Filter, RF Bandpass Filter
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